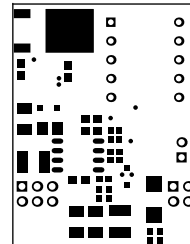
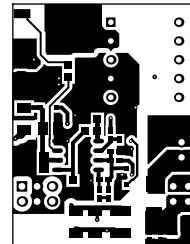


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 1/24/2024 5:56:58 PM	TEXAS INSTRUMENTS	

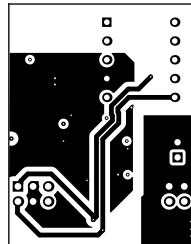


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 1/24/2024 5:56:58 PM	TEXAS INSTRUMENTS	

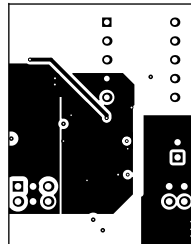
Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0.40mil	3.5	
1	Top Layer		1.40mil		
	Dielectric 1		8.00mil	4.2	
	Dielectric1		8.00mil	4.2	
2	Signal Layer 1		1.40mil		
	Dielectric 3	FR-4	24.40mil	4.2	
3	Signal Layer 2		1.40mil		
	Dielectric 2		8.00mil	4.2	
	Dielectric 4		8.00mil	4.2	
4	Bottom Layer		1.40mil		
	Bottom Solder	Solder Resist	0.40mil	3.5	
	Bottom Overlay				



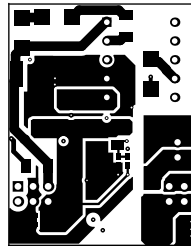
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 1/24/2024	5:56:59 PM	TEXAS INSTRUMENTS



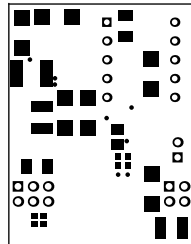
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME =	TID #: N/A		
PLOT NAME = Signal Layer 1	GENERATED : 1/24/2024 5:56:59 PM		TEXAS INSTRUMENTS



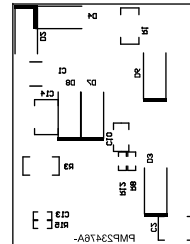
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME =	TID #: N/A		
PLOT NAME = Signal Layer 2	GENERATED : 1/24/2024 5:56:59 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 1/24/2024 5:56:59 PM	TEXAS INSTRUMENTS	



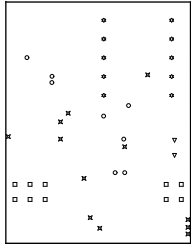
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 1/24/2024 5:57:00 PM	TEXAS INSTRUMENTS	



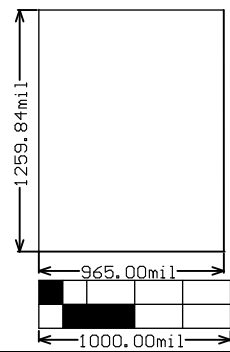
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 1/24/2024 5:57:00 PM	TEXAS INSTRUMENTS	



Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
✕	12	0.203mm (8.00mil)	PTH	Round	Top Layer - Bottom Layer	
○	8	0.254mm (10.00mil)	PTH	Round	Top Layer - Bottom Layer	
☆	10	0.750mm (29.53mil)	PTH	Round	Top Layer - Bottom Layer	
▽	2	0.850mm (33.47mil)	PTH	Round	Top Layer - Bottom Layer	
□	10	0.900mm (35.43mil)	PTH	Round	Top Layer - Bottom Layer	
	42 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 1/24/2024 5:57:00 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23476	REV: A	SUN REV: Not in version control
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 1/24/2024 5:57:00 PM	TEXAS INSTRUMENTS	

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